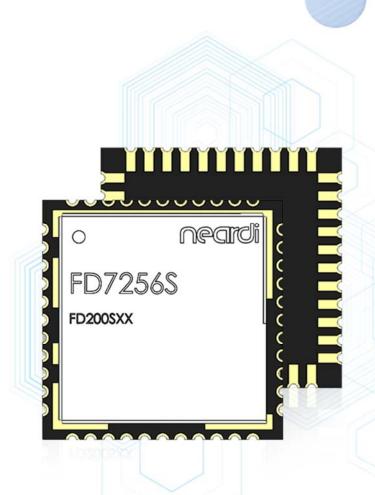


FD7256S WIFI Module

Datasheet

V2.2



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Version History

| Version | Date | Illustrate |
|---------|-----------|--|
| V1.0 | 2023/5/17 | Initial Version |
| V1.1 | 2023/9/15 | Add hardware design guide |
| V1.2 | 2023/9/22 | Update pin description |
| V2.0 | 2023/12/1 | Update Mechanical Specifications, RF Characteristics, Interface Design Notice |
| V2.1 | 2024/1/5 | Update WiFi Receive Sensitivity Spec |
| V2.2 | 2024/1/29 | Update Wake-up Signal Pin Name |
| | | |

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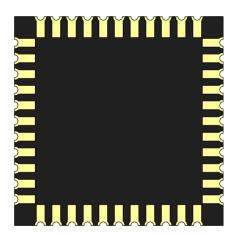
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1 Product Overview

1.1 Product Introduction

FD7256S is a highly integrated, low-cost combo module with high-performance and low-power. It supports Wi-Fi 6 and Bluetooth 5.0 protocol, supports Wi-Fi MAC of the final version of Wi-Fi 6 Wave2 protocol, Wi-Fi Baseband of 1T1R, and high-performance RF. It also supports SDIO3.0, HS-UART and PCM interfaces for connection with the Host. This module also supports BT and Wi-Fi to work in coexistence mode. It is suitable for consumer electronics such as IPC, tablet and IOT, and can also be used in fields with high reliability requirements such as industrial interconnection.





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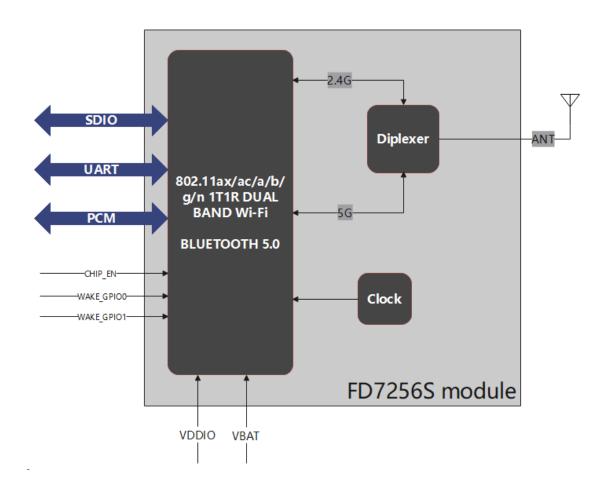
1.2 Wi-Fi Characteristics

- ✓ IEEE 802.11a/b/g/n/ac/ax (supports wave-2) wireless LAN communication protocol
- ✓ IEEE 802.11 d/e/h/i/k/mc/r/v/w
- ✓ Phy rate up to 600.5Mbps, Throughput rate up to 520Mbps
- ✓ Multiple modes such as Wi-Fi STA, AP, and P2P
- ✓ 2.4G 40MHZ, 5G 80MHz bandwidth, 1T/1R
- ✓ Up to 1024QAM modulation, supports LDPC and STBC
- ✓ UL/DL OFDMA, DL MU-MIMO
- ✓ QoS, WFA WMM, WMM PS
- ✓ RSSI and CSI Reporting
- ✓ Beamformee and 4*1 Tx Beamforming
- ✓ WPA, WPA2, WPA3 encryption and decryption, WAPI and WPS2.0
- ✓ ER, DCM to improve transceiver gain
- ✓ 20in40/80/160, 80in160 HE PPDU, Partial band MU MIMO to improve air interface utilization;
- ✓ BSS Color, Spatial Reuse to improve air interface utilization
- ✓ TWT, Intra-PPDU PS, VHT TXOP PS to optimize dynamic power consumption in small bandwidth and multi-BSS environment

1.3 Bluetooth Characteristics

- ✓ Support Bluetooth (Classic BT+BLE) v2.1, v3.0, v4.2, v5.0 features
- ✓ SDIO interface for BT data transmission.
- ✓ PCM/IIS interface for audio transmission
- ✓ BR/EDR/LE 1M/LE 2M/LE LR
- ✓ Support sco and esco link
- ✓ SSP/Secure Connection
- ✓ Low power mode (sniff, sniff sub-rating)
- ✓ Support BT/Wi-Fi coexistence

1.4 Block Diagram



1.5 Parameters

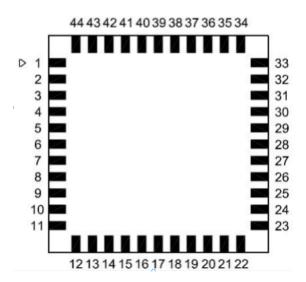
| Product Name | FD7256S | | |
|------------------------|--|--|--|
| Product description | 802.11ax/ac/a/b/g/n 1T1R dual band Wi-Fi and Bluetooth 5.0 comb module | | |
| Dimension | 12.0(±0.1)mm*12.0(±0.1)mm*1.65(±0.2)mm | | |
| Power supply | VBAT: 3.0~3.6V; VDDIO: 1.62V~1.92V/3.0V~3.6V | | |
| Host interface | SDIO3.0 + UART + PCM | | |
| Footprint | LCC 44pin | | |
| Operating temperature | -30°C to 70°C | | |
| Operating humidity | 10% to 90% (Non-Condensing) | | |
| Storage temperature | - 40°C to 85°C | | |

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2 Pin Definition

2.1 Pin Number

Top view



2.2 Pin Description

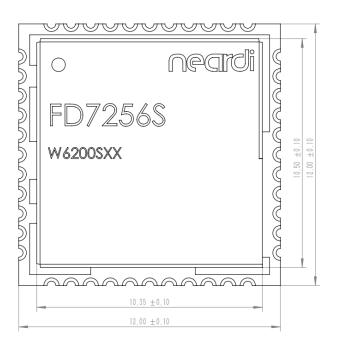
| Pin Number | Pin Name | Pin Type | Pin Description |
|------------|---------------|----------|--------------------------------------|
| 1 | GND | G | Ground connections |
| 2 | WL_BT_ANT | RF | Wi-Fi & BT antenna I/O port |
| 3 | GND | G | Ground connections |
| 4 | NC | - | Floating (Don't connected to ground) |
| 5 | NC | - | Floating (Don't connected to ground) |
| 6 | NC | - | Floating (Don't connected to ground) |
| 7 | NC | - | Floating (Don't connected to ground) |
| 8 | GND | - | Ground connections |
| 9 | VBAT | Р | Main power voltage source input |
| 10 | NC | - | Floating (Don't connected to ground) |
| 11 | NC | - | Floating (Don't connected to ground) |
| 12 | CHIP_EN | I | Module enable signal |
| 13 | WAKE_GPIO0 | I/O | Wake up signal with auto negotiation |
| 14 | SDIO_DATA_2 | I/O | SDIO data line 2 |
| 15 | SDIO_DATA_3 | I/O | SDIO data line 3 |
| 16 | SDIO_DATA_CMD | I/O | SDIO command line |

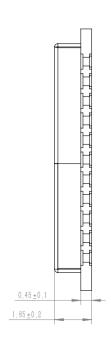
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| THE CHI OTHER | | | 170123000 |
|---------------|---------------|-----|--------------------------------------|
| 17 | SDIO_DATA_CLK | I/O | SDIO clock line |
| 18 | SDIO_DATA_0 | I/O | SDIO data line 0 |
| 19 | SDIO_DATA_1 | I/O | SDIO data line 1 |
| 20 | GND | G | Ground connections |
| 21 | NC | - | Floating (Don't connected to ground) |
| 22 | VDDIO | Р | I/O Voltage supply input |
| 23 | NC | - | Floating (Don't connected to ground) |
| 24 | NC | - | Floating (Don't connected to ground) |
| 25 | PCM_OUT | 0 | PCM Data output |
| 26 | PCM_CLK | I/O | PCM clock |
| 27 | PCM_IN | I | PCM data input |
| 28 | PCM_SYNC | I/O | PCM sync signal |
| 29 | NC | - | Floating (Don't connected to ground) |
| 30 | NC | - | Floating (Don't connected to ground) |
| 31 | GND | G | Ground connections |
| 32 | NC | - | Floating (Don't connected to ground) |
| 33 | GND | G | Ground connections |
| 34 | WAKE_GPIO1 | I/O | Wake up signal with auto negotiation |
| 35 | NC | - | Floating (Don't connected to ground) |
| 36 | GND | G | Ground connections |
| 37 | NC | - | Floating (Don't connected to ground) |
| 38 | NC | - | Floating (Don't connected to ground) |
| 39 | NC | - | Floating (Don't connected to ground) |
| 40 | NC | - | Floating (Don't connected to ground) |
| 41 | UART_RTS_N | I/O | UART DCE request send signal |
| 42 | UART_TXD | I/O | UART TX signal |
| 43 | UART_RXD | I/O | UART RX signal |
| 44 | UART_CTS_N | I/O | UART DEC clear send signal |
| | | | |

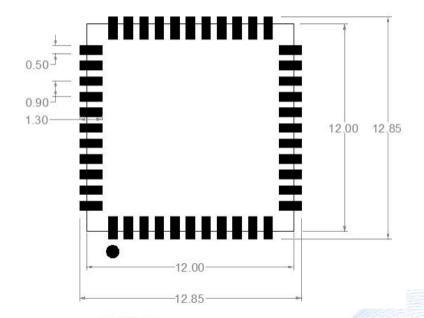
3 Mechanical Specifications

3.1 Mechanical Dimensions





3.2 Recommended PCB Layout Footprint



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4 Electrical Performance and Reliability

4.1 Absolute Maximum Voltage Range

| Symbol | Description | Min | Max | Unit |
|--------|-------------------------------------|------|-------|------|
| VBAT | Power Supply Voltage | -0.5 | 5.25* | V |
| VDDIO | Digital/Bluetooth/SDIO/ I/O Voltage | -0.5 | 5.25 | V |

^{*} If the voltage exceeds this value, the chip will be irreversibly damaged.

4.2 Recommended Operation Conditions

| Symbol | Description | Min | Type | Max | Unit |
|---------|---------------------------------------|------|--------|------|------|
| Ta | Ambient Operating Temperature | -30 | 25 | 70 | °C |
| Antenna | External Antenna VSWR | | 1.92:1 | 2:01 | |
| VBAT | Power Supply Voltage | 3 | 3.3 | 3.6 | V |
| VDDIO | Digital/Bluetoeth/CDIO/1/OVelters | 1.62 | 1.8 | 1.92 | V |
| VDDIO | Digital/Bluetooth/SDIO/ I/O Voltage - | 3 | 3.3 | 3.6 | V |

4.3 Power On/Off Sequence



| Symbol | Description | Min | Туре | Max | Unit |
|--------|--|-----|------|-----|------|
| 1 | VBAT Ramp up time | 0.2 | 0.5 | - | mS |
| 2 | VDDIO should be powered on after VBAT is powered on | 0 | - | - | mS |
| 3 | CHIP_EN should be powered on after VDDIO is powered on | 0 | - | - | mS |
| 4 | CHIP_EN reset time | 50 | | - | mS |

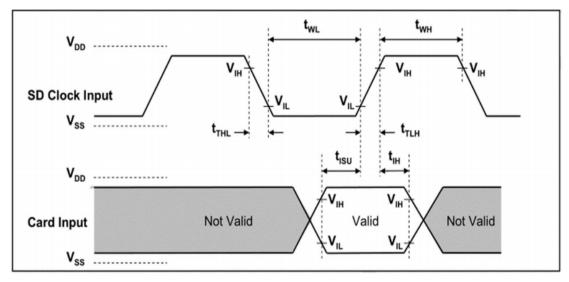
4.4 Reliability

| ltem | Test Model | Class | Level | Criteria |
|----------|------------|-------|----------|---------------------------------------|
| 565 | нвм | 2 | 2000V | ANSI/ESDA/JEDEC JS-001- 2017 |
| ESD | CDM | C2a | 500V | ANSI/ESDA/JEDEC JS-002- 2018 |
| l atalaa | Current | II A | 200mA | JEDEC STANDARD NO.78F JANUARY 2022 |
| Latch-up | Voltage | II A | 1.5xVmax | JEDEC STANDARD NO.78F JANUARY 2022 |

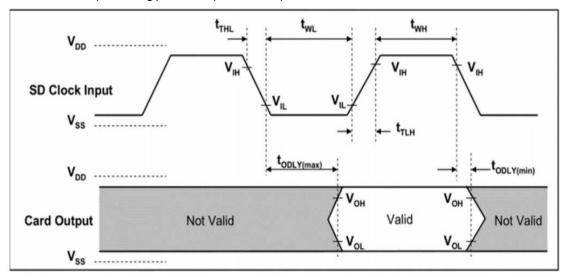
5 Interface Timing Parameters

5.1 SDIO Interface Timing

5.1.1 Default Speed Mode



SDIO device input timing(Default Speed Mode)



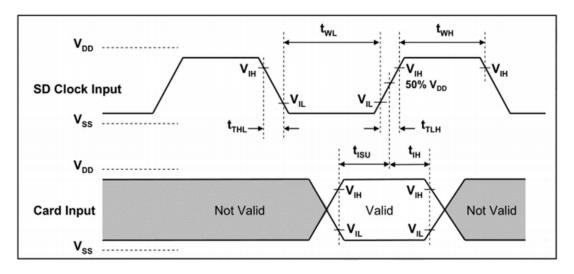
SDIO device output timing (Default Speed Mode)

| Parameter | Symbol | Min | Max | Unit | Remark |
|-------------------------------|--------|-----|-----|------|---------------|
| | Clock | | | | |
| Clock Freq Data Transfer Mode | fPP | 0 | 25 | MHZ | Cload ≤ 10 pF |

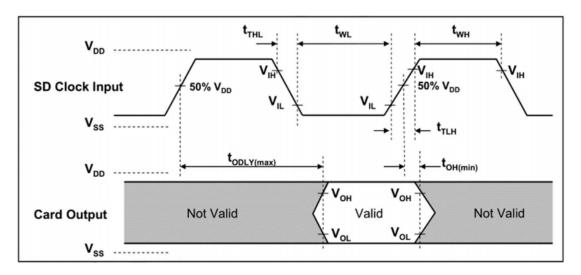


| Clock Freq Identification Mode | fO | 0 | 400 | KHZ | Cload ≤ 10 pF |
|---|----------------|---------------|-----|-----|---------------|
| Clock low time | wxya | 10 | | ns | Cload ≤ 10 pF |
| Clock high time | tWH | 10 | | ns | Cload ≤ 10 pF |
| Clock rise time | tTLH | | 10 | ns | Cload ≤ 10 pF |
| Clock fall time | tTHL | | 10 | ns | Cload ≤ 10 pF |
| Inputs | CMD,DAT(refer | enced to CLK) | | | |
| Input set-up time | tISU | 5 | | ns | Cload ≤ 10 pF |
| Input hold time | tIHU | 5 | | ns | Cload ≤ 10 pF |
| Output | s CMD,DAT(refe | renced to CLk | () | | |
| Output Delay time during Data Transfer Mode | tODLY | 0 | 14 | ns | Cload ≤ 40 pF |
| Output Delay time during Identification Mode | tODLY | 0 | 50 | ns | Cload ≤ 40 pF |
| | | | | | |

5.1.2 High-Speed Mode



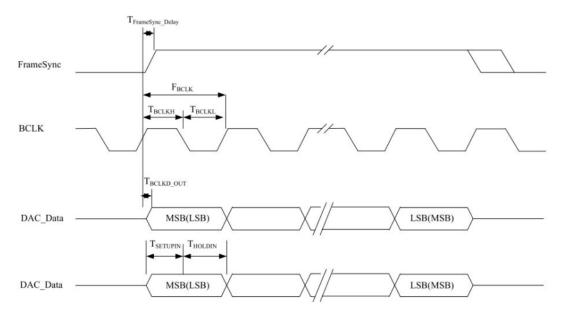
SDIO device input timing (High Speed Mode)



SDIO device output timing (High Speed Mode)

| Parameter | Symbol | Min | Max | Unit | Remark |
|--|------------------|-------------|------|------|---------------|
| | Clock | | | | |
| Clock Freq Data Transfer Mode | fPP | 0 | 50 | MHZ | Cload ≤ 10 pF |
| Clock Freq Identification Mode | fO | 0 | 400 | KHZ | Cload ≤ 10 pF |
| Clock low time | wxya | 7 | | ns | Cload ≤ 10 pl |
| Clock high time | tWH | 7 | | ns | Cload ≤ 10 p |
| Clock rise time | tTLH | | 3 | ns | Cload ≤ 10 p |
| Clock fall time | tTHL | | 3 | ns | Cload ≤ 10 p |
| Input | s CMD,DAT(refer | enced to CI | _K) | | |
| Input set-up time | tISU | 6 | | ns | Cload ≤ 10 p |
| Input hold time | tIHU | 2 | | ns | Cload ≤ 10 p |
| Outpu | its CMD,DAT(refe | renced to C | CLK) | | |
| Output Delay time during Data Transfer Mode | tODLY | 0 | 14 | ns | Cload ≤ 40 p |
| Output Delay time during Identification Mode | tODLY | 2.5 | | ns | Cload ≤ 15 p |

5.2 PCM Interface Timing



PCM Bus Timing

6 RF Characteristics

6.1 2.4GHZ Wi-Fi Radio Frequency (RF) Characteristics

| Conditions: VBAT=3.3V; VDDIO: | =1.8V; Ta:25°C | | | | | | | |
|---|---|----------------------------|---|-------------------------------|--|--|--|--|
| Features | Description | | | | | | | |
| Wi-Fi Standard | IEEE 802.11b/g/n/ac/ax | | | | | | | |
| Frequency Range | 2.4~2.4835GHz(2.4GHz ISM Band) | | | | | | | |
| Channels | Ch1~Ch13 | | | | | | | |
| | 802.11b (DSSS): CCK, DQPSK, DBPSK; | | | | | | | |
| | 802.11g (OFDM): BPSK, QP | SK, QAM16, Q | AM64; | | | | | |
| Modulation | 802.11n (OFDM): BPSK, QPS | SK, QAM16, Q | AM64; | | | | | |
| Wodulation | 802.11ac (OFDM): BPSK, QF | PSK, QAM16, (| QAM64, QA | M256; | | | | |
| | 802.11ax (OFDMA): BPSK, B | BPSK_DCM, QF | SK, QPSK_D | OCM, QA | M16, | | | |
| | QAM16_DCM, QAM64, QAI | M256, QAM10 |)24; | | | | | |
| | 802.11b: 1, 2, 5.5, 11Mbps; | | | | | | | |
| | 802.11g: 6, 9, 12, 18, 24, 36 | , 48, 54Mbps; | | | | | | |
| | 802.11n (HT20): MCS0~MC | S7 6.5~72.2M | bps; | | | | | |
| Date Rate | 802.11n (HT40): MCS0~MCS7 13.5~150Mbps; | | | | | | | |
| Date Rate | 802.11ac(VHT20): MCS0~MCS8 6.5~86.7Mbps; | | | | | | | |
| | 802.11ac(VHT40): MCS0~MCS9 13.5~200Mbps; | | | | | | | |
| | 802.11ax (HE20): MCS0~MCS11 8~143.4Mbps; | | | | | | | |
| | 802.11ax (HE40): MCS0~MCS11 16~286.8Mbps; | | | | | | | |
| Frequency Tolerance | ≤±5ppm | | | | | | | |
| 2.4G Transmitter Specifications | | | | | | | | |
| | | TX | | | VBAT | | | |
| Modulation | TX Rate | Power | TX EVM | TX | current | | | |
| Modulation | TX Nate | (± | (dB) M | Mask | (mA) | | | |
| | | 2dBm) | | | (1117) | | | |
| 802.11b | | | | | | | | |
| | 1Mbps | 17 | ≤35% | PASS | 413 | | | |
| 802.11b | 1Mbps 11Mbps | 17 17 | ≤35% ≤35% | PASS PASS | 413 253 | | | |
| 802.11b 802.11g | • | | | | | | | |
| | 11Mbps | 17 | ≤35% | PASS | 253 | | | |
| 802.11g | 11Mbps 6Mbps | 17 17 | ≤35% ≤-5 | PASS PASS | 253 256 | | | |
| 802.11g 802.11g | 11Mbps 6Mbps 54Mbps | 17 17 15 | ≤35% ≤-5 ≤-25 | PASS PASS PASS | 253 256 317 | | | |
| 802.11g 802.11g 802.11n | 11Mbps 6Mbps 54Mbps HT20 MCS0 | 17 17 15 17 | ≤35% ≤-5 ≤-25 ≤-5 | PASS PASS PASS | 253 256 317 251 | | | |
| 802.11g 802.11g 802.11n 802.11n | 11Mbps 6Mbps 54Mbps HT20 MCS0 HT20 MCS7 | 17 17 15 17 | ≤35% ≤-5 ≤-25 ≤-5 ≤-27 | PASS PASS PASS PASS PASS | 253 256 317 251 253 | | | |
| 802.11g 802.11g 802.11n 802.11n 802.11n | 11Mbps 6Mbps 54Mbps HT20 MCS0 HT20 MCS7 HT40 MCS0 | 17 17 15 17 14 | ≤35% ≤-5 ≤-25 ≤-5 ≤-27 ≤-5 | PASS PASS PASS PASS PASS PASS | 253 256 317 251 253 254 | | | |

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|------------------------------|------------|--------------------------------|--------------------------------|------|-------------------------|
| 802.11ac | VHT40 MCS0 | 17 | ≤-5 | PASS | 251 |
| 802.11ac | VHT40 MCS9 | 12 | ≤-32 | PASS | 188 |
| 802.11ax | HE20 MCS0 | 17 | ≤-5 | PASS | 224 |
| 802.11ax | HE20 MCS11 | 11 | ≤-35 | PASS | 210 |
| 802.11ax | HE40 MCS0 | 17 | ≤-5 | PASS | 234 |
| 802.11ax | HE40 MCS11 | 11 | ≤-35 | PASS | 150 |
| 2.4G Receiver Specifications | | | | | |
| Modulation | RX Rate | Min Input Level (dBm) | Max Input Level (dBm) | PER | VBAT current (mA) |
| 802.11b | 1Mbps | ≤-96 -5 | | 8% | 77.8 |
| 802.11b | 11Mbps | ≤-87 | -5 | 8% | 77.8 |
| 802.11g | 6Mbps | ≤-92 | -5 | 10% | 80.4 |
| 802.11g | 54Mbps | ≤-75 | -5 | 10% | 80.7 |
| 802.11n | HT20 MCS0 | ≤-92 | -5 | 10% | 82.8 |
| 802.11n | HT20 MCS7 | ≤-72 | -5 | 10% | 84.5 |
| 802.11n | HT40 MCS0 | ≤-89 | -5 | 10% | 86.7 |
| 802.11n | HT40 MCS7 | ≤-70 | -5 | 10% | 89.7 |
| 802.11ac | VHT20 MCS0 | ≤-91 | -5 | 10% | 83.1 |
| 802.11ac | VHT20 MCS8 | ≤-68 | -5 | 10% | 84.9 |
| 802.11ac | VHT40 MCS0 | ≤-89 | -5 | 10% | 87.2 |
| 802.11ac | VHT40 MCS9 | ≤-63 | -5 | 10% | 90.6 |
| 802.11ax | HE20 MCS0 | ≤-92 | -5 | 10% | 83.6 |
| 802.11ax | HE20 MCS11 | ≤-60 | -5 | 10% | 83.6 |
| 802.11ax | HE40 MCS0 | ≤-89 | -5 | 10% | 87.6 |
| 802.11ax | HE40 MCS11 | ≤-58 | -5 | 10% | 88.5 |
| | | | | | |

6.2 5GHZ Wi-Fi RF Characteristics

| Conditions: | VBAT=3.3V; VDDIO=1.8V; Ta:25℃ |
|-------------|---|
| Features | Description |
| Wi-Fi | IFFF 202 11a /rs/ca/cs |
| Standard | IEEE 802.11a/n/ac/ax |
| Frequency | 5.15~5.25GHz; 5.25~5.35GHz; 5.47~5.73GHz; 5.735~5.835GHz (5GHz ISM Band) |
| Range | 3.13~3.23GHZ, 3.23~3.33GHZ, 3.47~3.73GHZ, 3.733~3.033GHZ (3GHZ ISIVI Ballu) |
| Channels | Ch36,Ch40, Ch44, Ch48; Ch52~Ch64; Ch100~Ch140; Ch149~Ch165 |
| | 802.11a (OFDM): BPSK, QPSK, QAM16, QAM64; |
| | 802.11n (OFDM): BPSK, QPSK, QAM16, QAM64; |
| Modulation | 802.11ac (OFDM): BPSK, QPSK, QAM16, QAM64, QAM256; |
| | 802.11ax (OFDMA): BPSK, BPSK_DCM, QPSK, QPSK_DCM, QAM16, QAM16_DCM, QAM64, |
| | QAM256, QAM1024; |

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| | 802 11a· 6 9 12 | 40.04.06.40.5444 | | | | | | |
|----------------|---|-------------------------|-----------------|---------|--------------|--|--|--|
| _ | 002.114.0,3,12, | 18, 24, 36, 48, 54Mbps; | | | | | | |
| | 802.11n (HT20): N | исso~мсs7: 6.5~72.2м | bps; | | | | | |
| _ | 802.11n (HT40): N | MCS0~MCS7: 13.5~150N | Иbps; | | | | | |
| _ | 802.11ac (VHT20) | : MCS0~MCS8: 6.5~86.7 | Mbps; | | | | | |
| Date Rate | 802.11ac (VHT40) | : MCS0~MCS9: 13.5~20 | 0Mbps; | | | | | |
| _ | 802.11ac (VHT80): MCS0~MCS9: 29.3~433.3Mbps; 802.11ax (HE20): MCS0~MCS11: 8~143.4Mbps; 802.11ax (HE40): MCS0~MCS11: 16~286.8Mbps; | | | | | | | |
| _ | | | | | | | | |
| _ | | | | | | | | |
| _ | 802.11ax (HE80): | MCS0~MCS11: 34~600. | 5Mbps; | | | | | |
| Frequency | | | | | | | | |
| Tolerance | ≤±5ppm | | | | | | | |
| 5G Transmitte | r Specifications | | | | | | | |
| | | | | | VBAT current | | | |
| Modulation | TX Rate | TX Power (±2dBm) | TX EVM (dB) | TX Mask | (mA) | | | |
| 802.11a | 6Mbps | 17 | ≤-5 | PASS | 276 | | | |
| 802.11a | 54Mbps | 15 | ≤-25 | PASS | 342 | | | |
| 802.11n | HT20 MCS0 | 17 | ≤-5 | PASS | 273 | | | |
| 802.11n | HT20 MCS7 | 14 | ≤-27 | PASS | 276 | | | |
| 802.11n | HT40 MCS0 | 17 | ≤-5 | PASS | 258 | | | |
| 802.11n | HT40 MCS7 | 14 | ≤-27 | PASS | 232 | | | |
| 802.11ac | VHT20 MCS0 | 17 | ≤-5 | PASS | 273 | | | |
| 802.11ac | VHT20 MCS8 | 13 | ≤-30 | PASS | 242 | | | |
| 802.11ac | VHT40 MCS0 | 17 | ≤-5 | PASS | 258 | | | |
| 802.11ac | VHT40 MCS9 | 12 | ≤-32 | PASS | 186 | | | |
| 802.11ac | VHT80 MCS0 | 17 | ≤-5 | PASS | 256 | | | |
| 802.11ac | VHT80 MCS9 | 12 | ≤-32 | PASS | 285 | | | |
| 802.11ax | HE20 MCS0 | 17 | ≤-5 | PASS | 247 | | | |
| 802.11ax | HE20 MCS11 | 11 | ≤-35 | PASS | 221 | | | |
| 802.11ax | HE40 MCS0 | 17 | ≤-5 | PASS | 243 | | | |
| 802.11ax | HE40 MCS11 | 11 | ≤-35 | PASS | 149 | | | |
| 802.11ax | HE80 MCS0 | 17 | ≤-5 | PASS | 246 | | | |
| 802.11ax | HE80 MCS11 | 11 | ≤-35 | PASS | 267 | | | |
| 5G Receiver Sp | pecifications | | | | | | | |
| | | Min Input Level | Max Input Level | | VBAT current | | | |
| Modulation | RX Rate | (dBm) | (dBm) | PER | (mA) | | | |
| 802.11a | 6Mbps | -91 | -5 | 10% | 87.5 | | | |
| 802.11a | 54Mbps | -74 | -5 | 10% | 88.1 | | | |
| 802.11n | HT20 MCS0 | -91 | -5 | 10% | 90.5 | | | |
| 802.11n | HT20 MCS7 | -71 | -5 | 10% | 92.7 | | | |
| 802.11n | HT40 MCS0 | -88 | -5 | 10% | 94.1 | | | |
| 802.11n | HT40 MCS7 | -69 | -5 | 10% | 98.2 | | | |
| 802.11ac | VHT20 MCS0 | -91 | -5 | 10% | 90.9 | | | |
| 00L.11ac | V11120 IVIC30 | -67 | -5 -5 | 10% | 92.4 | | | |

Neardillai商 FD7256S 802.11ac VHT40 MCS0 -88 -5 10% 95.6 802.11ac VHT40 MCS9 10% 98.7 -63 -5 802.11ac VHT80 MCS0 -85 -5 10% 102.5 802.11ac -59 VHT80 MCS9 -5 10% 109.2 HE20 MCS0 802.11ax -91 -5 10% 92.1 802.11ax HE20 MCS11 -60 -5 10% 92.5 802.11ax HE40 MCS0 -89 -5 10% 96.7 802.11ax -58 -5 10% 96.6 HE40 MCS11

-5

-5

10%

10%

105.3

106.5

6.3 Bluetooth Radio Frequency (RF) Characteristics

-86

-53

| Conditions: V | BAT=3.3V; VDDIO=1.8 | V; Ta:25℃ | | | | | | |
|-----------------------|--|-------------------------|-----------|---------|--|--|--|--|
| Features | Description | | | | | | | |
| Bluetooth Standard | Bluetooth v2.1+EDR/3.0+HS/4.2/5. 0 | | | | | | | |
| Frequency Range | 2.4~2.4835GHz | | | | | | | |
| Channels | Bluetooth Classic: Ch0~Ch78 (For 1MHz Channels); | | | | | | | |
| Channels | Bluetooth Low Energy | : Ch0~Ch39 (For 2MHz Ch | nannels); | | | | | |
| Power class | Bluetooth Classic: Clas | s1; | | | | | | |
| Power class | Bluetooth Low Energy | : Class1.5; | | | | | | |
| | BR_1Mbps: GFSK; | | | | | | | |
| | EDR_2Mbps: π/4-DQPSK; | | | | | | | |
| | EDR_3Mbps: 8DPSK; | | | | | | | |
| Modulation | LE_125Kbps: GFSK (Coded_S=8); | | | | | | | |
| | LE_500Kbps: GFSK (Coded_S=2); | | | | | | | |
| | LE_1Mbps: GFSK (Uncoded); | | | | | | | |
| | LE_2Mbps: GFSK (Unco | oded); | | | | | | |
| Bluetooth Tra | nsmitter Specifications | | | | | | | |
| | | TX Power (dBm) | | VBAT | | | | |
| Item | Min | Туре | Max | current | | | | |
| | IVIIII | туре | IVIAX | (mA) | | | | |
| BR_1M | 6 | 8 | 10 | 31 | | | | |
| EDR_2M | 6 | 8 | 10 | 31 | | | | |
| /3M | | | 10 | | | | | |
| LE_125/500K | 6 | 8 | 10 | 31 | | | | |
| LE_1M | 6 | 8 | 10 | 31 | | | | |
| LE_2M | 6 | 8 | 10 | 31 | | | | |
| Bluetooth Rece | iver Specifications | | | | | | | |

802.11ax

802.11ax

HE80 MCS0

HE80 MCS11

| | Sensitivity (dBm) | | Max Inpu | t Level | |
|-----------|--------------------|--------|----------|---------|---------|
| | Sensitivity (dbin) | (dBm) | | VBAT | |
| Item | | | Input | | current |
| | Input Level (Typ) | BER | Level | BER | (mA) |
| | | | (Typ) | | |
| BR_1Mbps | <-88 | 0.10% | > -20 | TBD | TBD |
| EDR_2Mbps | - < 86 | 0.01% | > -20 | TBD | TBD |
| EDR_3Mbps | <-83 | 0.01% | > -20 | TBD | TBD |
| BLE | <-88 | 30.80% | > -20 | TBD | TBD |

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7 Hardware Design Guide

7.1 Power Design Notice

7.1.1 Voltage Requirement

The main power supply (VBAT) input range of the module is 3.3V+/-10%, and the interface VDDIO supports two level ranges, 1.8V+/-10% or 3.3V+/-10%. Due to the ripple of the main power can affect the RF performance of Wi-Fi and Bluetooth, therefore the power supply ripple VPP is required to be less than 50mV.

7.1.2 Current Requirement

Under different standards, when Wi-Fi transmits continuously, the peak value and amplitude of the operating current on the main power supply are as shown in the table below. The 3.3V power converter must be able to provide 650mA RMS current and fast transient response (when the transient current change rate is 80mA/us, the voltage drop is less than 100mV).

| Mode | Burst power (dBm) | Peak current (mA) | RMS current (mA) |
|--------------|-------------------|-------------------|------------------|
| 11b 11M long | 23.5 | 833 | 607 |
| 2.4G ch1 | 21.8 | 753 | 573 |
| | 19.6 | 647 | 473 |
| | 17.4 | 593 | 440 |
| | 15.5 | 566 | 407 |
| 11ax MCS0 | 22 | 720 | 500 |
| 2.4G CH1 | 20 | 640 | 427 |
| | 18 | 587 | 420 |
| | 16 | 553 | 393 |
| 11ax MCS0 | 22 | 827 | 560 |
| 5G CH36 | 19.9 | 667 | 433 |
| | 18 | 620 | 380 |
| | 16 | 540 | 307 |
| | | | |

7.1.3 Power Supply Reference

Under different standards, when Wi-Fi transmits continuously, the peak value and amplitude of

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the operating current on the main power supply are as shown in the table below. The 3.3V power converter must be able to provide 650mA RMS current and fast transient response (when the transient current change rate is 80mA/us, the voltage drop is less than 100mV).

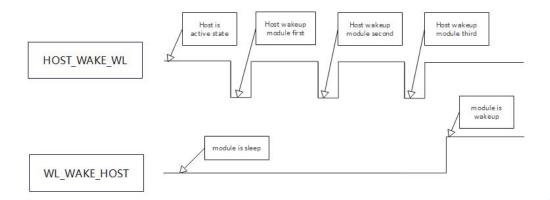
Note: The maximum peak current is over 800mA@23.5dBm Close to WIFI module L2106 3.3uH IND_303015 0.08ohm U2104 SY8089AAC VCC5V0 SYS VCC3V3 WL 1T1R SOT 23 5 Trace>60mil VTN C2153 100pF C2154 C2155 C2152 R2122 R2121 C2156 DNP C0402 X5R 16V R2123 33K R0402 1%

For the power on/off sequence of the module, please refer to the requirements in the "4.3 Power On/Off Sequence" chapter.

7.2 Interface Design Notice

7.2.1 Wake-up Signals

This module require two GPIOs as handshake signals with the host controller, the wake up direction of these two GPIOs support auto negotiation. As default, for example, WL_ WAKE_ HOST is the output signal "CP wakes up the Host", and HOST_ WAKE_ WL is the input signal "Host wakes up CP", also we can swap then when connect with the host. Wi-Fi and Bluetooth use the same handshake signal. The working mechanism is as follows.



7.2.2 HCI Commend Interface

The Bluetooth supports SDIO3.0 and HS-UART (4Mbps) as HCI (Host Controller Interface). SDIO3.0 is used as HCI by default, which means the HS-UART port does not need in the HOST controller.

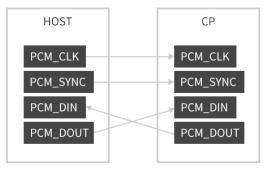
7.2.3 SDIO Interface

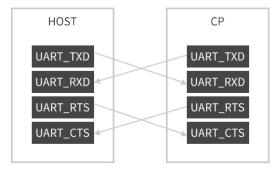
This module supports SDIO3.0. When the input level of VDDIO is 3.3v, SDIO supports the clock frequencies of 25MHz and 50MHz. When the input level of VDDIO is 1.8v, SDIO supports SDR25, SDR50 and SDR104, and the clock frequency of SDR104 is 208MHz.

The clock frequency of the SDIO3.0 interface is up to 208MHz. The SDIO bus needs to be controlled with a single-ended 50 ohm impedance. The maximum length of the bus routing is 15cm. The SDIO signal group needs to be controlled to be of equal length with 100mil.

7.2.4 PCM and UART Interface

As shown in the figure below, the PCM bus and UART bus and data lines between the Host and the module need to be cross-connected.





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8 Storage, Production and Packaging

8.1 Storage Conditions

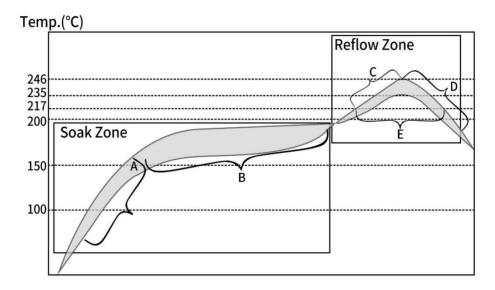
- ❖ FD7256S module is 3 (MSL3) and packed in a vacuum-sealed bag when shipped, the recommended storage temperature is 25±5°C, and the relative humidity is 35%∼60%. Under this condition, the module can be stored for 12 months.
- The Module shall be stored without opening the packing. After the packing opened, the module shall be completed the patch soldering within 24 hours.
- ❖ FD7256S module can be stored for no more than 168 hours in a workshop environment with a temperature of 25±5°C, a relative humidity below 60% and in compliance with IPC/JEDEC J-STD-033. It is not recommended to expose the module unpacked to the air for a long time. If not immediately patch soldering, it is recommended to store the module in a moisture-proof cabinet with a relative humidity of less than 10% to keep the module dry.
- ❖ If the module is not stored according to the above recommended method, it needs to be baked at high temperature (120±5°C) for 8 hours. The re-baked module shall be patched within 24 hours.
- Please pay attention to ESD protection when unpacking and handling modules.

8.2 Production Welding

During the production welding process, please do not use any organic solvents (such as alcohol, isopropanol, acetone, trichloroethylene, etc.) to wipe the shield of the FD7256S module, otherwise it may cause the shield to rust. Please do not ultrasonically clean the module, it may cause damage to the crystal inside the module. Please make sure that the spray material used will not chemically react with the module shield or PCB and will not flow into the module when spraying modules.

In order to ensure the welding quality and reliability of the FD7256S module, the thickness of the printed stencil is recommended to be 0.15~0.18mm; the recommended reflow curve is as follows:





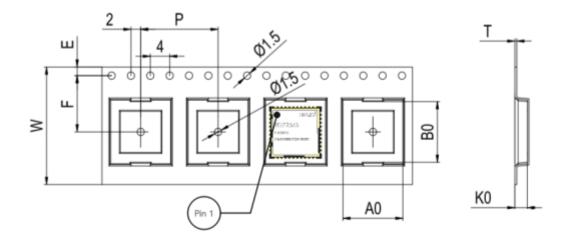
Recommended reflow curve

| Item | Description | Value |
|----------------------------------|---|----------------|
| Endothermic Zone Heating Rate | Interval A | ≤3°C/s |
| Soak time | From the end of interval A to the beginning of interval B | 60~120s |
| Reflow Zone Heating Rate | Interval C | ≤3 °C/s |
| Maximum Temperature | Highest point of the curve | 246°C(+5/-0°C) |
| Cooling Rate | Interval D | <6 °C/s |
| Reflow Time | Interval E | 60~150 seconds |

8.3 Packing Specifications

The key parameters and packaging processes described in this chapter are for reference only. The appearance and structure of the specific packaging materials are subject to actual delivery.

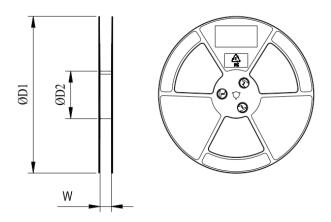
8.3.1 Tape Dimensions



Tape dimensions

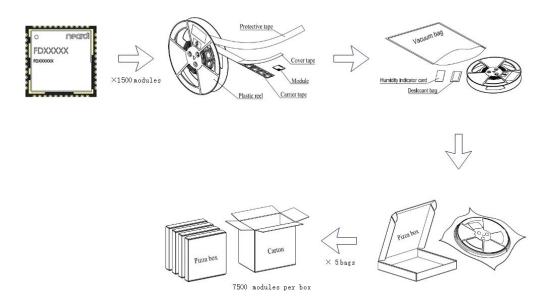
| W | P | Т | A0 | В0 | КО | F | E. | Unit |
|----|----|------|------|------|-----|------|------|------|
| 24 | 16 | 0.35 | 12.4 | 12.4 | 2.5 | 11.5 | 1.75 | mm |

8.3.2 Plastic Reel Dimensions



| ФD1 | φD2 | W | unit |
|-----|-----|----|------|
| 330 | 100 | 24 | mm |

8.3.3 Packaging Process



Package specification